SCLS019D - MARCH 1984 - REVISED AUGUST 2003

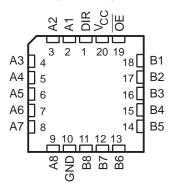
- Operating Voltage Range of 4.5 V to 5.5 V
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 14 ns

SN54HCT645 . . . J OR W PACKAGE SN74HCT645 . . . DW, N, NS, OR PW PACKAGE (TOP VIEW)

DIR	1	\bigcup_{20}] v _{cc}
A1	2	19] OE
A2	[]3	18] B1
АЗ	4	17] B2
A4	[5	16] B3
A5	6	15] B4
A6	[]7	14] B5
A7	8	13] B6
A8	9	12] B7
GND	10	11] B8

- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible
- True Logic

SN54HCT645 . . . FK PACKAGE (TOP VIEW)



description/ordering information

These octal bus transceivers are designed for asynchronous two-way communication between data buses. These devices transmit data from the A bus to the B bus or from the B bus to the A bus, depending upon the level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP – N	Tube of 20	SN74HCT645N	SN74HCT645N	
	2010 5141	Tube of 25	SN74HCT645DW	1107045	
	SOIC - DW	Reel of 2000	SN74HCT645DWR	HCT645	
-40°C to 85°C	SOP - NS	Reel of 2000	SN74HCT645NSR	HCT645	
		Tube of 70	SN74HCT645PW		
	TSSOP - PW	Reel of 2000	SN74HCT645PWR	HT645	
		Reel of 250	SN74HCT645PWT		
	CDIP – J	Tube of 20	SNJ54HCT645J	SNJ54HCT645J	
-55°C to 125°C	CFP – W	Tube of 85	SNJ54HCT645W	SNJ54HCT645W	
	LCCC - FK	Tube of 55	SNJ54HCT645FK	SNJ54HCT645FK	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



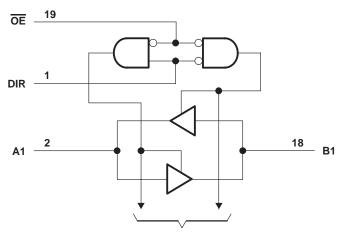
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FUNCTION TABLE

INP	UTS	OPERATION			
OE	DIR	OPERATION			
L	L	B data to A bus			
L	Н	A data to B bus			
Н	Χ	Isolation			

logic diagram (positive logic)



To Seven Other Transceivers

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input clamp current, IIK (VI < 0 or VI > VCC) (se	e Note 1)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VCO	c) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})		±35 mA
Continuous current through V _{CC} or GND		±70 mA
Package thermal impedance, θ_{JA} (see Note 2):	DW package	58°C/W
-	N package	69°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

			SN	54HCT6	45	SN	74HCT6	45	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	\$ 5.5	4.5	5	5.5	V
VIH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	2	Š	, ,	2			V
VIL	Low-level input voltage	V _{CC} = 4.5 V to 5.5 V		100	0.8			0.8	V
VI	Input voltage		0	1	VCC	0		VCC	V
VO	Output voltage		0	2	VCC	0		VCC	V
Δt/Δν	Input transition rise/fall time		0~)	500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST CONDITIONS			Т	A = 25°C	;	SN54HCT645		SN74HCT645		
PAR	AMETER	TEST CON	DITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
V		Vi. Vi. anVi.	I _{OH} = -20 μA	45.1/	4.4	4.499		4.4		4.4		V
VOH		$V_I = V_{IH}$ or V_{IL}	$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		V
.,		V VV	I _{OL} = 20 μA	4.5.1/		0.001	0.1		0.1		0.1	.,
VOL		$V_I = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	V
II	DIR or OE	$V_I = V_{CC}$ or 0		5.5 V		±0.1	±100		±1000		±1000	nA
loz	A or B	$V_O = V_{CC}$ or 0		5.5 V		±0.01	±0.5	4	±10		±5	μΑ
ICC		$V_I = V_{CC}$ or 0,	IO = 0	5.5 V			8	2	160		80	μΑ
Δlcc†	-	One input at 0.5 V o Other inputs at 0 or		5.5 V		1.4	2.4	PAO	3		2.9	mA
Ci	DIR or OE			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

DADAMETED	ARAMETED FROM TO		V	T,	4 = 25°C	;	SN54HCT645	SN74HCT645	
PARAMETER	(INPUT)	(OUTPUT)	vcc	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT
	A = = D	D A	4.5 V		16	22	33	28	
^t pd	A or B	B or A	5.5 V		14	20	30	25	ns
	ŌĒ	A == D	4.5 V		25	46	69	58	
^t en	OE	A or B	5.5 V		22	41	62	52	ns
	ŌĒ	A D	4.5 V		26	40	6 0	50	
^t dis	OE	A or B	5.5 V		23	36	70 54	45	ns
		A or B	4.5 V		9	12	18	15	
t _t		AUIB	5.5 V		8	11	16	14	ns

SN54HCT645, SN74HCT645 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

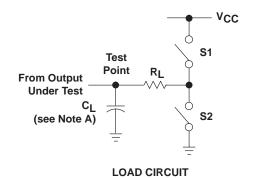
DADAMETED	FROM TO		.,	T,	λ = 25°C	;	SN54HCT6	645	SN74H	CT645	
PARAMETER	(INPUT)	(OUTPUT)	vcc	MIN	TYP	MAX	MIN N	IAX	MIN	MAX	UNIT
	A == D	D A	4.5 V		20	30		45		38	
^t pd	A or B	B or A	5.5 V		18	27	,(0)	41		34	ns
	ŌĒ	A == D	4.5 V		36	59	ODIE	89		74	
^t en	OE	A or B	5.5 V		30	53	6,66	80		67	ns
4.		A or B	4.5 V	·	17	42		63		53	20
t _t		AUID	5.5 V		14	38		57		48	ns

operating characteristics, $T_A = 25^{\circ}C$

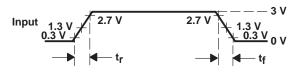
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per transceiver	No load	40	pF



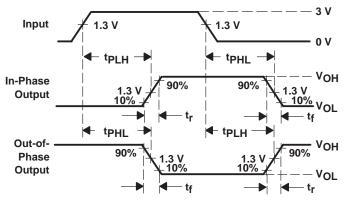
PARAMETER MEASUREMENT INFORMATION

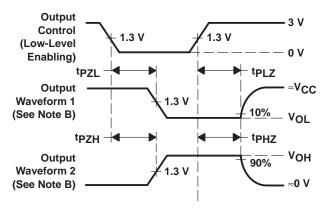


PARAM	/IETER	R _L C _L		S1	S2
	tPZH	1 k Ω	50 pF or	Open	Closed
^t en	tPZL	1 K22	150 pF	Closed	Open
4	tPHZ	1 k Ω	50 pF	Open	Closed
^t dis	tPLZ	1 K22	50 pr	Closed	Open
t _{pd} or	t _t		50 pF or 150 pF	Open	Open



VOLTAGE WAVEFORM INPUT RISE AND FALL TIMES





VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT RISE AND FALL TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns, $t_f = 6$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.

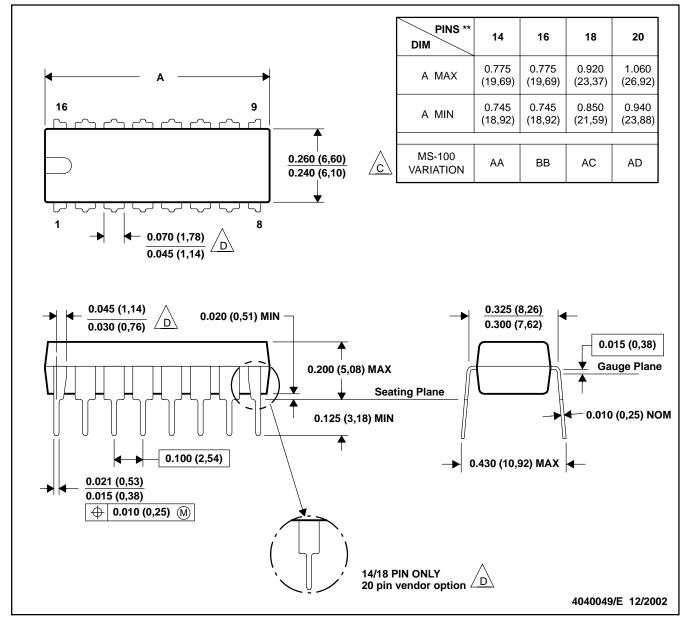
Figure 1. Load Circuit and Voltage Waveforms



N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

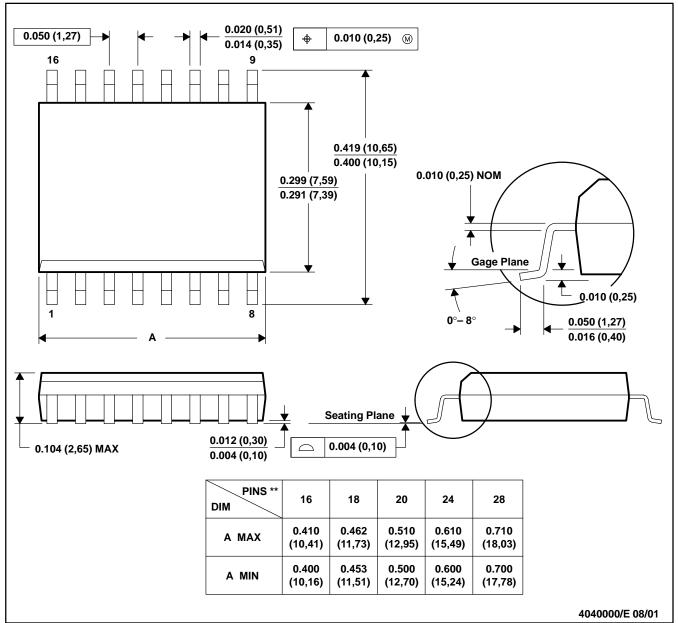
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

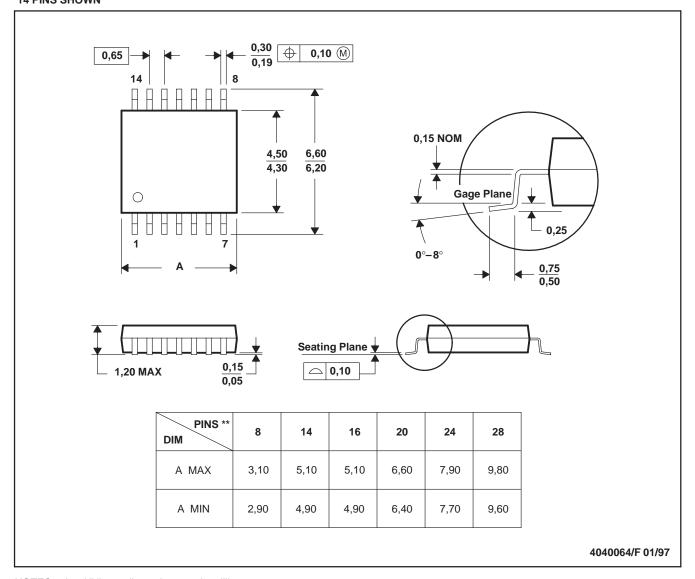
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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